

#### **AMP**

TE Internal #: 531353-6

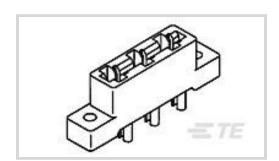
Card Edge Power Connectors, Board-to-Board, 8 Position, 7.92 mm

[.312 in] Centerline, Power, 8 Power Positions

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Connectors > PCB Connectors > Card Edge Connectors > Card Edge Power Connectors



Connector System: Board-to-Board

Number of Positions: 8

Centerline (Pitch): 7.92 mm [ .312 in ]

Connector & Contact Terminates To: Printed Circuit Board

Contact Current Rating (Max): 30 A

### **Features**

## **Product Type Features**

Connector System	Board-to-Board
Connector & Contact Terminates To	Printed Circuit Board

## **Configuration Features**

PCB Mount Orientation	Vertical
Number of Positions	8
Number of Power Positions	8

## **Electrical Characteristics**

Operating Voltage	250 VAC
operating voitage	200 17 10

#### **Contact Features**

Contact Layout	Inline
Contact Type	Socket
Contact Underplating Material	Nickel
Contact Base Material	Copper Alloy
Contact Current Rating (Max)	30 A
Contact Mating Area Plating Material	Tin

#### **Termination Features**

## Mechanical Attachment



Connector Mounting Type	Board Mount
Housing Features	
Housing Material	Glass Filled Polyester
Centerline (Pitch)	7.92 mm[.312 in]
Dimensions	
Power Contact Centerline	7.92 mm[.312 in]
Usage Conditions	
Operating Temperature Range	-40 – 95 °C[-40 – 203 °F]
Operation/Application	
Circuit Application	Power
Industry Standards	
UL Flammability Rating	UL 94V-0
Packaging Features	
Packaging Quantity	160
Packaging Method	Carton

## **Product Compliance**

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Not Compliant
EU ELV Directive 2000/53/EC	Compliant with Exemptions
China RoHS 2 Directive MIIT Order No 32, 2016	Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2023 (235)  Candidate List Declared Against: JUNE 2023 (235)  SVHC > Threshold:  Pb (13% in Component Part)  Article Safe Usage Statements:  Do not eat, drink or smoke when using this product. Wash thoroughly after handling. Recycle if possible and dispose of the article by following all applicable governmental regulations relevant to your geographic location.
Halogen Content	Not Low Halogen - contains Br or Cl > 900 ppm.
Solder Process Capability	Wave solder capable to 240°C

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as



EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

## Compatible Parts





# Customers Also Bought













### **Documents**

Product Drawings

HI CURRENT ASSY 8 POS

English

**CAD Files** 

3D PDF

3D



**Customer View Model** 

ENG\_CVM\_CVM\_531353-6\_K.2d\_dxf.zip

English

**Customer View Model** 

ENG\_CVM\_CVM\_531353-6\_K.3d\_igs.zip

English

**Customer View Model** 

ENG\_CVM\_CVM\_531353-6\_K.3d\_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

**Product Specifications** 

**Application Specification** 

English

**Agency Approvals** 

Agency Approval Document

English